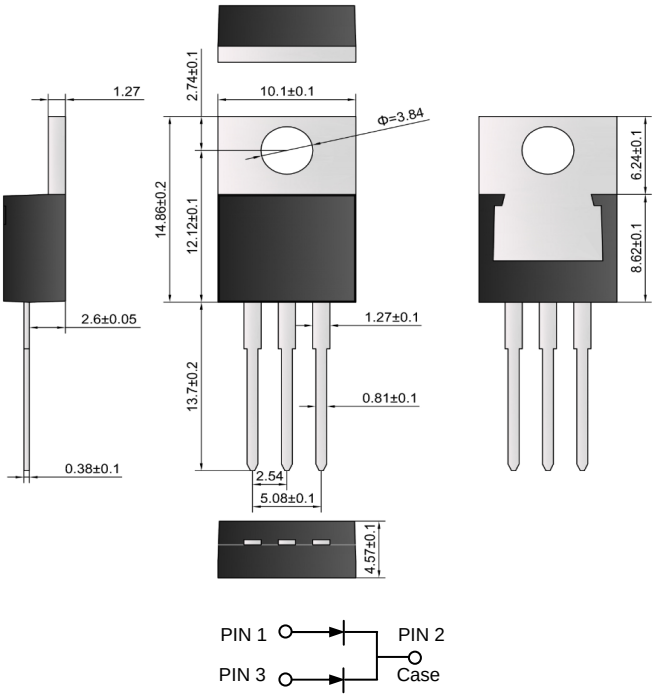
Features

- Glass Passivated Die Construction
- Superfast 35nS and 50nS Recovery Time
- Low Forward Voltage Drop
- Low Reverse Leakage Current
- High Surge Current Capability
- Epoxy Meets UL 94V-0 Classification
- Ideally Suited for Use in High Frequency SMPS, Inverters and As Free Wheeling Diodes

TO-220



Mechanical Data

- Case: TO-220, Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 1.9 grams (approx.)
- Mounting Position: Any
- Mounting Torque: 0.6 N.m Max.

Maximum Ratings and Electrical Characteristics @T_A=25°C unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	MUR 3020CT	MUR 3030CT	MUR 3040CT	MUR 3060CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200	300	400	600	V
RMS Reverse Voltage	$V_{R(RMS)}$	140	210	280	420	V
Average Rectified Output Current Total Device @T_C = 110°C Per Diode	I_O	30 15				A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	200				A
Forward Voltage per diode @I_F = 15A	V_{FM}	1.05	1.25		1.7	V
Peak Reverse Current @T_C = 25°C At Rated DC Blocking Voltage @T_C = 100°C	I_{RM}	10 500				μA
Reverse Recovery Time (Note 1)	t_{rr}	35	50			nS
Typical Junction Capacitance (Note 2)	C_J	175			145	pF
Thermal Resistance Junction to Ambient per diode Thermal Resistance Junction to Case per diode	$R_{\theta JA}$ $R_{\theta JC}$	60 2.4				°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150				°C

Note: 1. Measured with I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A.
2. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

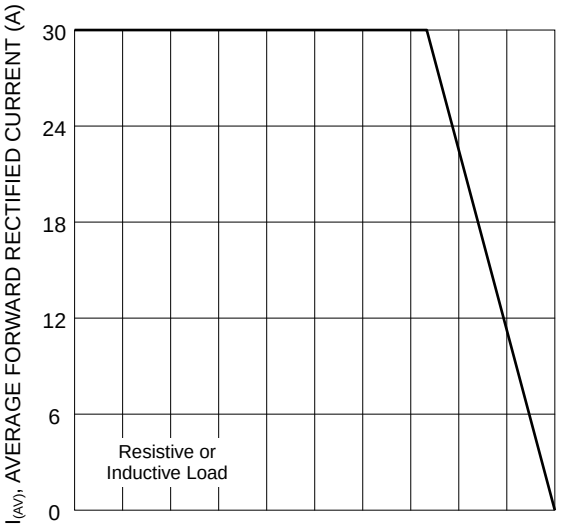


Fig. 1 Forward Current Derating Curve

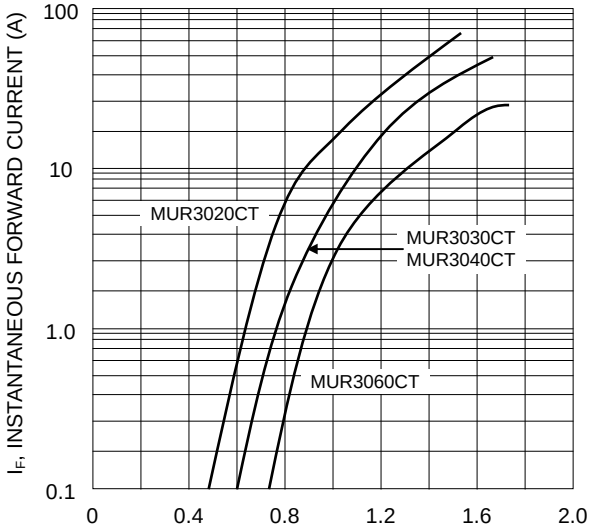


Fig. 2 Typical Forward Characteristics

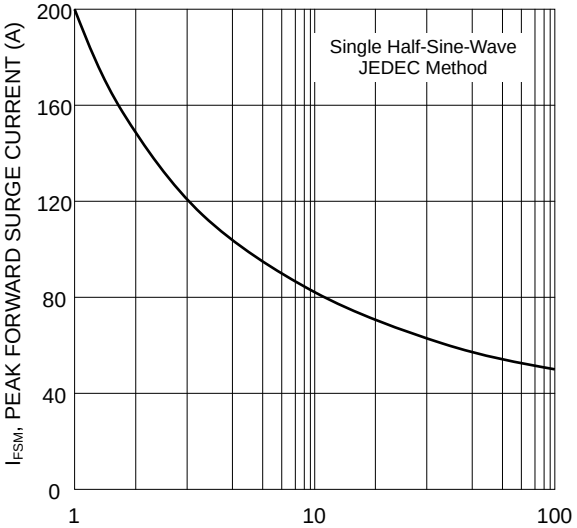


Fig. 3 Forward Surge Current Derating Curve

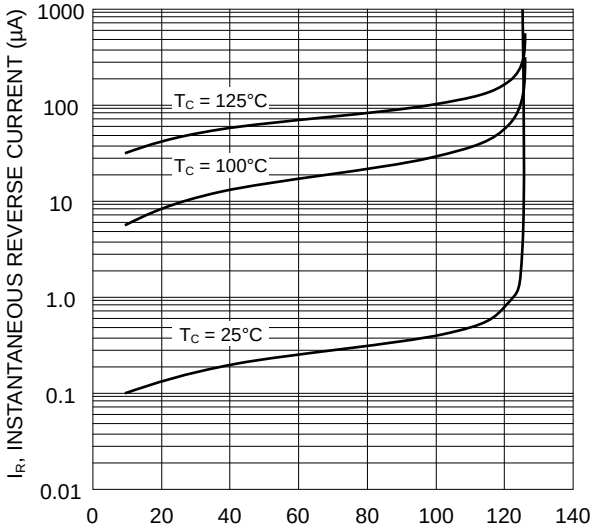


Fig. 4 Typical Reverse Characteristics

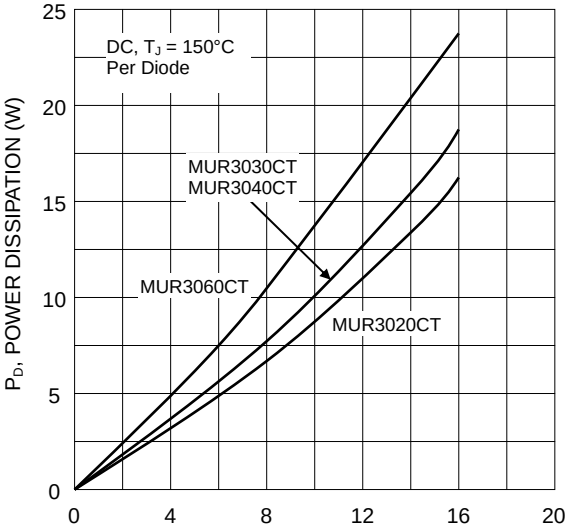


Fig. 5 Forward Power Dissipation

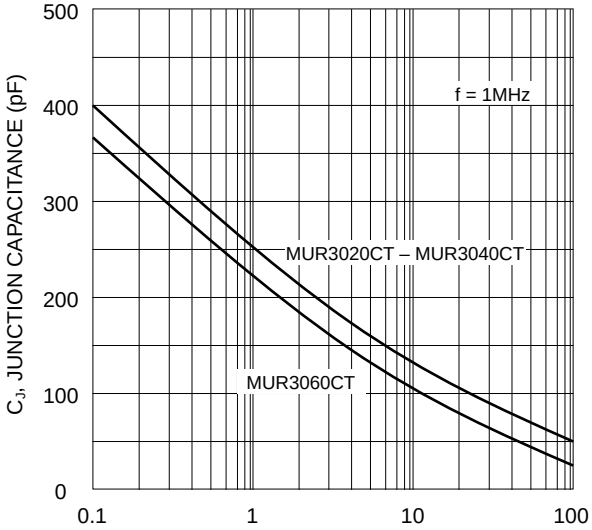
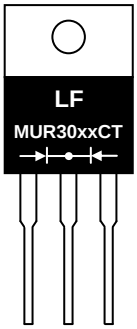


Fig. 6 Typical Junction Capacitance

MARKING INFORMATION



MUR30xxCT = Device Number
x = 20, 30, 40 or 60
Polarity = As Marked on Body

PACKAGING INFORMATION

BULK

Tube Size L x W x H (mm)	Quantity (PCS)	Inner Box Size L x W x H (mm)	Quantity (PCS)	Carton Size L x W x H (mm)	Quantity (PCS)	Approx. Gross Weight (KG)
525 x 31 x 6	50	555 x 145 x 95	2,000	572 x 306 x 218	8,000	19.0

Note: 1. Anti-static tube, water clear color.

RECOMMENDED SCREW MOUNTING ARRANGEMENT

Recommended isolated mounting when screw is at heatsink potential. 4-40 hardware is used.

Screw should not be tightened with any type of air-forced torque or equipment that may cause high impact on device package. The insulating bushing inside the mounting hole will insure the screw threads do not contact the metal base.

The interface should apply a layer of thermal grease or a highly conductive thermal pad for better heat dissipation.